

POLYCOL® THICK-COAT

1. DESCRIPTION

POLYCOL® THICK-COAT is a very high solids and viscosity, fast exposing pre-sensitized red SBQ emulsion specially formulated for creating thick stencils and for drip-free coating on coarse mesh counts. POLYCOL® THICK-COAT is plastisol, UV, water and solvent resistant.

POLYCOL® THICK-COAT builds up quickly and has exceptional edge definition and resolution. Unlike most emulsions used for making thick stencils, POLYCOL® THICK-COAT develops (washes out) very quickly saving valuable processing time. POLYCOL® THICK-COAT's solvent resistance prevents solvents from "locking in" the emulsion making reclaiming easier.

TIP: To optimize the emulsion's resistance to water-based and discharge ink systems, be sure the emulsion is extremely dry at the time of exposure. Also, select the longest possible exposure time to enhance durability and to avoid pre-mature stencil breakdown.

NOTE: For maximum resistance to aggressive ink systems, the use of Diazo D and a stencil hardener may be required for longer print runs. See SENSITIZING and POST HARDENING below for more information.

2. SENSITIZING

Pre-sensitized -- ready to use. If needed, Diazo D – supplied separately at no charge upon request – may be used when printing with water-based and discharge ink systems.

3. DEGREASING

To achieve consistent, good quality stencils, degrease mesh with a good quality commercial degreaser such as KIWO's DEGREASER 1:20 CONCENTRATE or ULTRA PREP. For degreasers used in automatic equipment, KIWO offers a specially formulated machine grade degreaser KIWOCLEAN DEGREASER 1:40 CONCENTRATE. See separate Technical Information sheets for further details regarding KIWO's degreasers.

For best results, thoroughly brush both sides of screen with degreasing agent. Using a pressure washer to remove degreaser will help remove stubborn mesh contaminates, but may also re-introduce impurities to the mesh caused by blowback from the washout booth. To reduce blowback risk, perform a final flood rinse using low water pressure.

Mesh should be free of all contaminates such as ink and emulsion residues, oil, dust, and ghost/haze images prior to emulsion coating.

4. COATING PROCEDURE

Coating can be done manually or by machine. The use of a KIWOMAT® coating machine is especially recommended because it achieves a more reproducible coating result. When coating manually, begin on the substrate side of the screen with wet-on-wet coats until emulsion surfaces on the squeegee side (generally 2 coats when using round edged coating trough). Then finish with wet-on-wet coats on the squeegee side to build up the emulsion coating to the desired thickness depending on the printing requirements.

POLYCOL® THICK-COAT has excellent coating properties on mesh counts of 40-305 threads per inch (16-120 threads per cm). For standard stencil thickness, the following coating techniques are recommended using a round (2 - 2.5 mm) edged coating trough:

40-86 tpi (16-34 tpcm):	2-1 wet-on-wet
110-156 tpi (43-61 tpcm):	2-1 wet-on-wet
195-305 tpi (77-120 tpcm):	2-1 wet-on-wet

For thick stencil applications, and due to varied screen room equipment and conditions, the correct coating technique for your process *must be determined through coating tests*. Contact KIWO for more specific coating techniques.

The following table can be used only as a very general guide:

Mesh tpi	Coating Technique*	Stencil Thickness
83-70 µm	2-2	~ 125 µm
83-70 µm	2-3	~ 180 µm
83-70 µm	2-4	~ 235 µm
83-70 µm	2-5	~ 300 µm

* Coated with a round (2.5 mm diameter) coating trough

5. DRYING

Dry emulsion coated screens in complete darkness, or under safelight conditions, in a horizontal position with the substrate side facing down. Temperature, relative humidity and airflow affect the drying time. Screens must be *dried thoroughly* before exposing to achieve highest chemical (ink and ink cleaners) and mechanical (abrasion) resistance. Environmental conditions play a vital role. Temperatures of 86°-104°F (30°-40°C) with a relative humidity of 30% - 50% maximum and moderate airflow are optimum conditions. Drying at room temperature and in uncontrolled conditions may lead to inconsistent results and varying screen resistance.

TIP: Keep screens and all screen handling areas dry until exposure is complete. This includes storage, exposure preparation, *and* exposure areas, as photo emulsions reabsorb moisture if reintroduced to high humidity environments. Emulsions do not become humidity resistant until exposure, washout and drying are complete.

6. EXPOSING

Expose with ultra-violet light at a wavelength of 350 – 420 nm. *Metal halide lamps provide the best results.* Due to the many variables that determine optimum exposure time, accurate exposure times cannot be given. The following examples are offered as a guide only.

Lamp: 5000 Watt metal halide at 40" (1m) distance:

Mesh Count tpi (tpcm)	Mesh Color	Coating Technique	Exposure Time
60-140 (24-140)	White	2-1	~ 40 sec.
83-70 (32-70)	Yellow	2-4	~ 2 min.



Correct exposure times for your equipment and mesh selection must be determined through exposure tests using an exposure calculator such as the KIWO® ExpoCheck.

Under-exposed screens feel slimy on the squeegee side during developing. At correct exposure time, the screen is not slimy. Overexposure leads to loss of small details. Correctly exposed screens will withstand high water pressure during washout.

Please contact KIWO if you have further questions regarding exposure time.

7. DEVELOPING / WASHOUT

Depending on the mesh count and stencil thickness one of the two following techniques work well:

High pressure developing: Wet both sides of the screen thoroughly with water, then after a short dwell time; wash out screen from the substrate side of the screen using a power washer (~1,500 psi) on fan spray setting at 12-18" distance until image is fully developed. Briefly rinse squeegee side to remove any remaining emulsion residue. Vacuum or blot excess water from screen.

Dip tank pre-soak technique: Commonly used for thick stencils used for high density printing, exposed screens can alternatively be placed into water dip tank for a few minutes to pre-soak and soften the unexposed emulsion. Remove screens after 3-5 minutes and begin high pressure developing technique described above.

8. POST-EXPOSURE

Post-exposing the screen after developing and drying is not very effective. To improve the resistance ~10-15% the post-exposure time needs to be 4x the original exposure time. Exposing the screen fully with the primary exposure offers better resistance than under exposing initially, then post-exposing to improve resistance. Post exposure is most often used for long printing runs when water based and/or abrasive inks are used.

9. POST-HARDENING (CHEMICALLY)

The emulsion can be chemically post-hardened using one of KIWO's stencil hardeners. Stencil hardeners can be classified as reclaimable or un-reclaimable. If reclaiming ability is desired, use KIWO HARDENER WR or HARDENER HP.

If a permanent un-reclaimable stencil is desired, for example when cataloging screens for future use, or when aggressive inks are used for very large print runs, use KIWO HARDENER K. See separate Technical Information sheets for further details regarding KIWO's stencil hardeners.

10. BLOCKOUT / TOUCH-UP

Retouching and blocking out can be done with KIWO's BLOCKOUT, RED BLOCKOUT or KIWOFILLER SR 401 NV. For a water resistance stencil, block out and retouch with KIWOFILLER SWR 22 or use POLYCOL® THICK-COAT (dry thoroughly and re-expose completely prior to using stencil hardeners). See separate Technical Information sheets for further details regarding KIWO's blockouts.

11. RECLAIMING

POLYCOL® THICK-COAT can be reclaimed with KIWO's STENCIL REMOVER 1:20 CONCENTRATE. Before reclaiming, ensure the screen is completely cleaned of ink or ink cleaning chemical residues. If water beads up on the stencil, residues are still present. If this is the case, degrease the screen again prior to reclaiming for best results. For best results, work both sides of the screen i.e. apply stencil remover, brush, and pressure wash both sides of the screen. After

applying stencil remover, a short dwell time may be used prior to pressure washing to allow more working time for the stencil remover especially when using coarser meshes and/or thicker stencils.

CAUTION: Never allow stencil removers to dry prior to removal, as the emulsion will become locked into the mesh and virtually impossible to remove. See separate Technical Information sheets for further details regarding KIWO's stencil removers.

12. HAZE REMOVING

To remove emulsion haze or ghost images left from the ink, use KIWO's HAZE REMOVER, FAST LIQUID HAZE REMOVER, or MEGA CLEAN ACTIVE.

For best results, HAZE REMOVER should be applied to a dry screen, then allowed to completely dry on the screen. For more effective ink ghost removal, HAZE REMOVER can be used in conjunction with KIWOCLEAN® CONCENTRATED INK WASH or ULTIMATE INK WASH to re-activate dried HAZE REMOVER.

Active components in FAST LIQUID HAZE REMOVER and MEGA CLEAN ACTIVE work in approximately five minutes and effectively remove both emulsion haze and ink ghost simultaneously. See separate Technical Information sheets for further details regarding KIWO's haze removers.

Haze removers, like ink washes and stencil removers should be worked into the screen mesh from both sides of the screen before removing for maximum effectiveness.

13. PHYSICAL PROPERTIES

Viscosity:	Approx. 60,000 mPas
Solids Content:	approx.: 51%
Color:	Light Red
Storage:	1 year at 68°F/20°C
Potlife:	1 year at 68°F/20°C
Pre-coated screens:	8 weeks in complete darkness at 68°F/20°C or 1-3 weeks when using diazo D
Freezing:	Protect against freezing
VOC:	None
TLV:	N/A
HMIS rating:	Health – 1 Flammability – 0 Reactivity – 0

14. PACKAGING

1 US Quart, 1 US Gallon, 5 US Gallons, 55 US Gallon Drum.

15. ADDITIONAL INFORMATION

For additional product information, please visit our web site at www.kiwo.com. All products mentioned in this technical data sheet are available through KIWO Inc. and its distributor network. For further information contact your authorized KIWO distributor or KIWO direct.

Thank you for choosing **KIWO**.